# SPECIFICATION FOR LCD MODULE

Model No. <u>TM162EBAWG</u>

Prepared by: Date: Checked by: Date: Verified by: Date: Approved by: Date:

TIANMA MICROELECTRONICS CO., LTD

## **REVISION RECORD**

Date	Ref. Page	Revision No.	Revision Items	Check & Approval

### 1 General Specifications:

1.1 Display type: STN/Yellow-Green

1.2 Display color\*:

Display color: Blue-Black

Background: Yellow-Green

1.3 Polarizer mode: Reflective/Positive

1.4 Viewing Angle: 6:00

1.5 Driving Method: 1/16 Duty 1/5 Bias

1.6 Without Backlight

• Color tone is slightly changed by temperature and driving voltage.

1.7 Display Fonts: 5 x 7 dots(1 Character)

1.8 Data Transfer: 8 Bit Parallel

1.9 Front Polarizer: SHC-125U

Rear Polarizer: SHC-125M

1.10 Operating Temperature: -20----+70°℃

Storage Temperature: -30----+90°℃

1.11 Outline Dimensions: Refer to outline drawing on next page

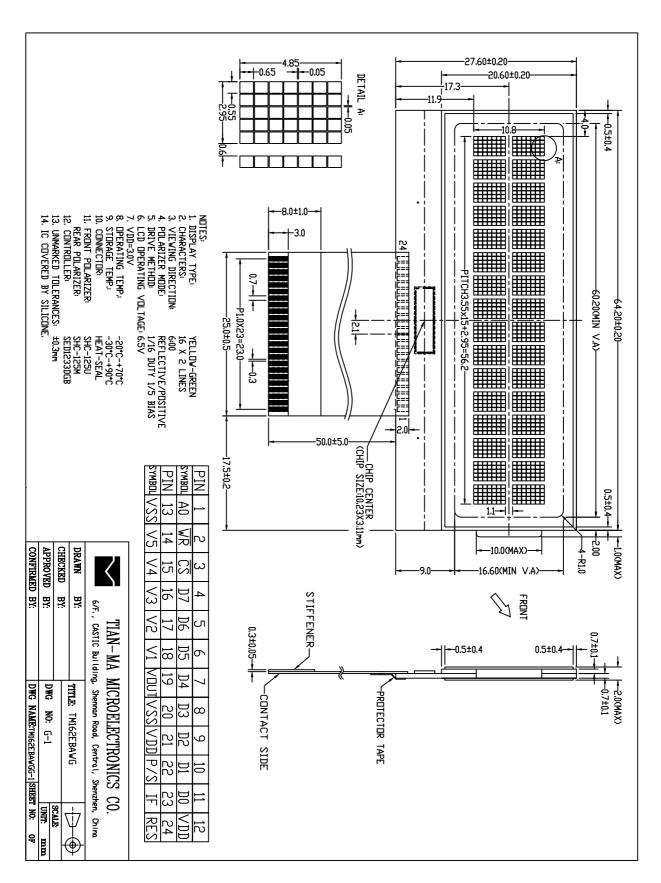
1.12 Dot Matrix: 16 Characters X 2

1.13 Dot Size: 0.55X0.65(mm)

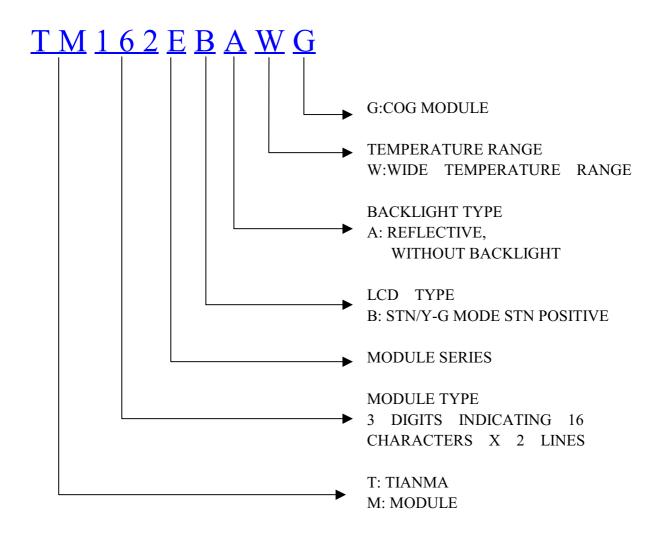
1.14 Dot Pitch: 0.6X0.7 (mm)

1.15 Weight: 10g

## 2 Outline Drawing



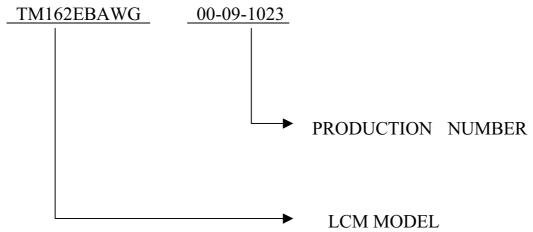
## 3 LCD Module Part Numbering System



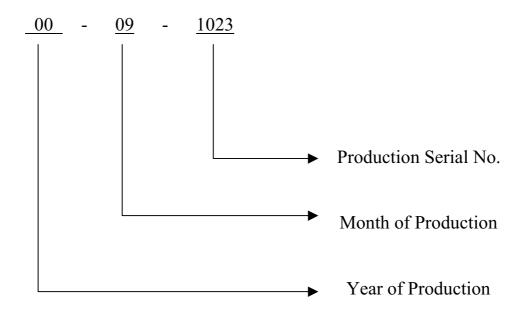
## **4 LCM Lots Numbering System**

LCM model and production number are printed on the LCM.

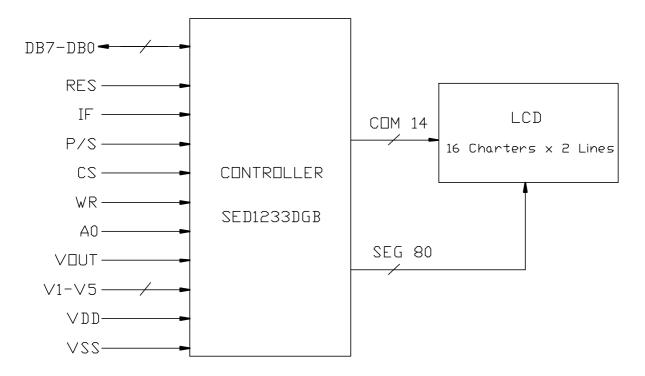
## Example:



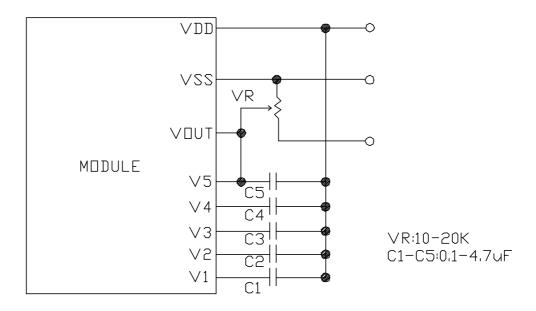
## PRODUCTION NUMBER:



## 5 Circuit Block Diagram



Block Diagram Example of Power Supply



Both the boosting circuit and the voltage control circuit are not used in this module.

Therefore, connect V5 pin with Vout pin and supply the LCD driving voltage from the outside.

# **6 Absolute Maximum Ratings**

Item	Symbol	Min.	Max.	Unit	Remark
Power Supply Voltage	V <sub>DD</sub> - V <sub>SS</sub>	-0.3	6.0	V	
LCD Driving Voltage	V <sub>LCD</sub>				
Operating Temperature Range	Тор	-20	+70	r	No
Storage Temperature Range	Тѕт	-30	+90	)	Condensation

# 7 Electrical Specifications and Instruction Code

# 7.1 Electrical characteristics

Iter	n	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage (Logic)		V <sub>DD</sub> - V <sub>SS</sub>	2.4	3.0	3.6	V
Supply Voltage (LCD Drive)		VLCD	5.5	6.5	7.5	V
Input	High	$V_{\text{\tiny IH}}$ $(V_{\text{DD}}=3.0)$	$0.7V_{DD}$	1	V <sub>DD</sub> +0.3	V
Signal Voltage	Low	$V_{\text{\tiny IL}}$ $(V_{\text{DD}}=3.0)$	-0.3	ı	0.2 V <sub>DD</sub>	V
Supply current (Logic)		$I_{DD}$ (VDD-VSS) $=3.0$	-	50	100	uA

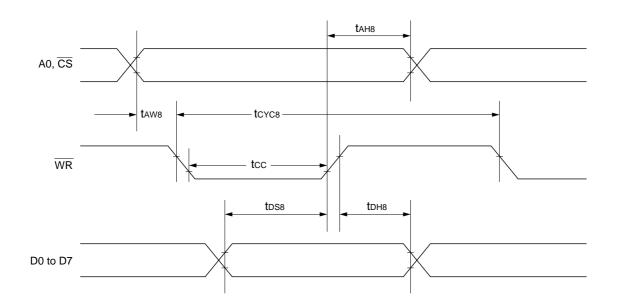
# 7.2 Interface Signals

Pin No.	Symbol	Level	Description						
1	A0	H/L	H:D0-D7 are display data						
			L:D0-D7 are controller com	nand					
2	${\mathrm{WR}}$	H/L	80 family MPU:WR Signal I	Input L:Active					
	,,,,,,		68 family MPU:Enable clock	c input					
-3	CS	H/L	Chip selects signal L:Active						
4	D7	H/L	Data Bus Line						
5	D6	H/L	Data Bus Line						
6	D5	H/L	Data Bus Line						
7	D4	H/L	Data Bus Line						
8	D3	H/L	Data Bus Line	Noconnection					
9	D2	H/L	Data Bus Line	at 4-bit operation					
10	D1	H/L	Data Bus Line						
11	D0	H/L	Data Bus Line						
12	Vdd	3.0V	Supply Voltage						
13	Vss	0V	Ground						
14	V5	-	Connect to Vdd and a capaci	tor of 0.1 – 4.7 uF					
15	V4	-	Connect to a capacitor of 0.1	−4.7 uF					
16	V3	-	Connect to a capacitor of 0.1	−4.7 uF					
17	V2	-	Connect to a capacitor of 0.1	−4.7 uF					
18	V1	-	Connect to a capacitor of 0.1	−4.7 uF					
19	Vout	-	Supply Voltage(LCD Drive)						
20	Vss	-	Ground						
21	Vdd	-	Supply Voltage (+3.0V)						
22	P/S	H/L	H:Parallel Data Transfer L	:Serial Data Transfer					
23	IF	H/L	Interface Data Length Select H:8-bits Parallel L:4-bit Parallel						
24	RES	H/L	Reset Signal						

# 7.3 Interface Timing Chart

#### **TIMING CHARACTERISTICS**

(1) System Bus Write Characteristic I (80 series MPU)



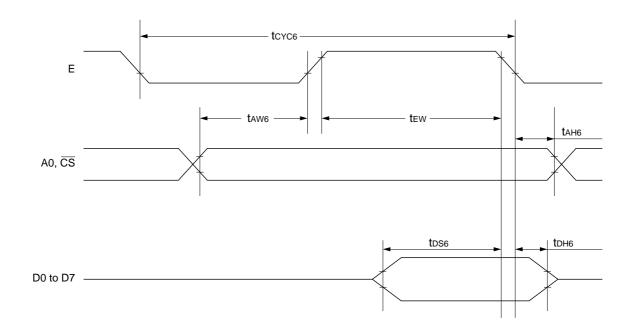
[Vss = -3.6 V to -2.4 V, Ta = -30 to  $85^{\circ}$ C unless otherwise specified]

Item	Signal	Symbol	Measuring condition	Min.	Max.	Unit
Address hold time	A0, CS	t AH8		30		ns
Address setup time		t AW8		60		ns
System cycle time	WR	t CYC8	Vss = -3.0	500		ns
			-2.7	550		
			-2.4	650		
Control pulse width (WR)		t cc	Vss = -3.0	100		ns
			-2.7	120		
			-2.4	150		
Data setup time	D0 ~ D7	t DS8		100		ns
Data hold time		t DH8		50		ns

<sup>\*1:</sup> For the rise and fall of an input signal, set a value not exceeding 25 ns. \*2: Every timing is specified on the basis of 20% and 80% of Vss.

<sup>\*3:</sup> For A0 and  $\overline{CS}$ , the same time is not required. Input signals so that A0 and  $\overline{CS}$  may satisfy tAW8 and tAH8 respectively.

#### (2) System Bus Write Characteristic II (68 series MPU)



[Vss = -3.6 V to -2.4 V, Ta = -30 to  $85^{\circ}$ C unless otherwise specified]

Item	Signal	Symbol	Measuring condition	Min.	Max.	Unit
System cycle time	A0, CS	t CYC6	Vss = -3.0	500		ns
			-2.7	550		
			-2.4	650		
Address setup time		t AW6		60		
Address hold time		t AH6		30		ns
Data setup time	D0 ~ D7	t DS6		100		ns
Data hold time		t DH6		50		ns
Enable pulse width	E	t EW	Vss = -3.0	100		ns
			-2.7	120		
			-2.4	150		

<sup>\*1:</sup>  $t_{CYC6}$  denotes the cycle of the E signal in the  $\overline{CS}$  active state.  $t_{CYC6}$  must be reserved after  $\overline{CS}$  becomes active. \*2: For the rise and fall of an input signal, set a value not exceeding 25 ns.

<sup>\*3:</sup> Every timing is specified on the basis of 20% and 80% of Vss.

<sup>\*4:</sup> For A0 and CS, the same timing is not required. Input signals so that A0 and CS may satisfy tAW6 and tAH6 respectively.

## 7.4 Instruction Code

Command					Co	de					Function
Command	A0	WR	D7	D6	D5	D4	D3	D2	D1	D0	runction
(1) Cursor Home	0	0	0	0	0	1	*	*	*	*	Moves the cursor to the home position.
(2) Static Display Control	0	0	0	0	1	0	*	*	SD S	1 D0	Sets the display mode of static display symbol SD1, SD0 = 0, 0 (display OFF), 0, 1 (1 - 2 Hz blink), 1, 0 ( 3 4 Hz blink), 1, 1 (all display ON)
(3) Display ON/OFF Control	0	0	0	0	1	1	С	В	DC	D	Sets cursor ON/OFF (C), cursor blink ON//OFF (B), double cursor ON/OFF (DC) and display ON/OFF (D).  C = 1 (cursor ON) 0 (cursor OFF), B = 1 (blink ON) 0 (blink OFF) DC = 1 (double cursor ON) 0 (double cursor OFF), D = 1 (display ON) D = 0 (display OFF)
(4) Power Save	0	0	0	1	0	0	*	*	0	PS	Sets power save ON/OFF (PS) and oscillating circuit ON/OFF (0).  PS = 1 (power save ON) 0 (power save OFF),  0 = 1 (oscillating circuit ON) 0 (oscillating circuit OFF)
(5) Power Control	0	0	0	1	0	1	0	VC	VF	P	Sets voltage regulating circuit ON/OFF and boosting circuit ON/OFF (P).  VC = 1 (voltage regulating circuit ON) 0 (voltage regulating circuit OFF) VF = 1 (voltage follower ON) 0 (voltage follower OFF), P = 1 (boosting circuit ON) 0 (boosting circuit OFF)
(6) System Set	0	0	0	1	1	0	N2	N1	*	CG	Sets the use or non-use of CG RAM and display lines (N2, N1).  CG = 1 (use of CG RAM) 0 (non-use of CG RAM), N2, N1 = 0, 0 (2 lines) 0, 1 (3 lines) 1, 0 (4 lines)
(7) Electronic Volume Register	0	0	0	1	1	1	MS	SB	L	SB	Sets the electronic volume register value.
(8) RAM Address Set	0	0	1			AD	DRI	ESS			Sets the DD RAM, CG RAM or symbol register address.
(9) RAM Write	1	0				DA	ATA			Writes data into the DD RAM, CG RAM or symbol register address.	

# **8 Optical Characteristics**

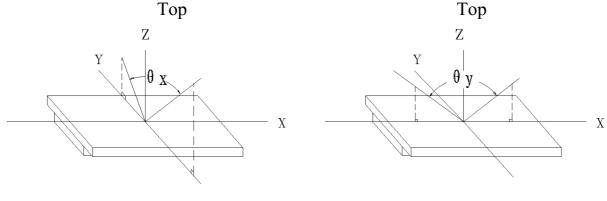
8.1 Optical Characteristics

Ta=25℃

The second secon									
Item		Symbol	Cone	dition	Min.	Тур.	Max.	Unit	
Viewing Angle		$\theta_{\mathbf{x}}$	C > 2	$\theta_y=0^\circ$	-35		20		
		$\theta_{\mathbf{y}}$	Cr≥2	$\theta_x = 0^{\circ}$	-30	)	30	Deg	
Contrast Ratio		Cr	$\theta_{x}=0^{\circ}$ $\theta_{y}=0^{\circ}$		4	1	-		
Response	Turn on	Ton	$\theta_{\mathbf{x}}$ =	=0°	-	-	250	ms	
Time	Turn off	Toff	$\theta_{\mathbf{y}^{\mathbf{z}}}$	=0°	-	-	250	ms	

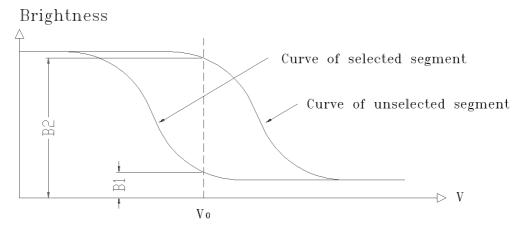
#### 8.2 Definition of Optical Characteristics

## 8.2.1 Definition of Viewing Angle



Bottom Bottom

#### 8.2.2 Definition of Contrast Ratio

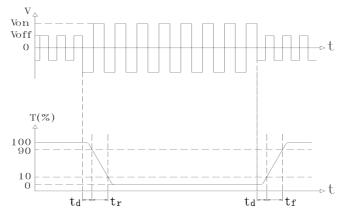


Contrast Ratio =  $B2/B1 = \frac{\text{unselected state brightness}}{\text{selected state brightness}}$ 

Measuring Conditions:

1) Frame frequency: 100.0Hz

## 8.2.3 Definition of Response time



Turn on time:  $t_{on} = t_d + t_r$ 

Turn off time:  $t_{off} = t_d + t_f$ 

Measuring Condition:

1) Operating Voltage: 6.5V

2) Frame frequency: 100.0Hz

# 9 Reliability

# 9.1 Environmental Test

Ta=25°C

No.	Test Item	Content of Test	Test condition
1	High Temperature Storage	Endurance test applying the high storage temperature for a long time	85℃ 240H
2	Low Temperature Storage	Endurance test applying the low storage temperature for a long time	-30°C 240H
3	High Temperature Operation	Endurance test applying the electric stress (voltage & current) and the thermal stress to the element for a long time	70℃ 240H
4	Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time	-20℃ 240H
5	High Temperature /Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time	70°C 95%RH 1000H (Non condensation)
6	Temperature Cycle	Endurance test applying the low and high temperature cycle -30°C \rightarrow 25°C \rightarrow 90°C \rightarrow 25°C 30min 5min 30min 5min	-30°C/90°C 10 cycles
7	Vibration Test (package state)	Endurance test applying the vibration during transportation	10Hz~500Hz, 100m/s², 120min
8	Shock Test (package state)	Endurance test applying the shock during transportation	Half- sine wave, 300m/s <sup>2</sup> , 18ms
9	Atmospheric Pressure Test	Endurance test applying the atmospheric pressure during transportation by air	25kPa 16H

# 9.2 Failure Judgment Criterion

Criterion			T	est i	Iter	n N	o.			Esilvas Indoonset Cuitorian
Item	1	2	3	4	5	6	7	8	9	Failure Judgement Criterion
Basic Specification	1	1	1	1	1	1	1	<b>V</b>	<b>V</b>	Out of the basic Specification
Electrical specification	<b>V</b>	<b>V</b>	<b>V</b>	1	<b>V</b>					Out of the electrical specification
Mechanical Specification							1	<b>V</b>		Out of the mechanical specification
Optical Characteristic	1	1	1	1	1	1			<b>V</b>	Out of the optical specification
Note	Fo	For test item refer to 9.1								
Remark		Basic specification = Optical specification + Mechanical specification								

# 10 QUALITY LEVEL

Examination	At T <sub>amb</sub> =25°℃	Inspection					
or Test	(unless otherwise stated)	Min.	Max.	Unit	IL	AQL	
External Visual Inspection	Under normal illumination and eyesight condition, the distance between eyes and LCD is 25cm.	See ann	nex A	П	Major 0.4 Minor 0.65		
Display Defects	Under normal illumination and eyesight condition, display on inspection.	See ann	nex B		II	Major 0.4 Minor 0.65	

Note: Major defects: Open segment or common, Short, Serious damages, Leakage

Miner defects: Others

Sampling standard conforms to GB2828

#### 11 Precautions for Use of LCD Modules

- 11.1 Handling Precautions
- 11.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 11.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 11.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 11.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 11.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
  - Isopropyl alcohol
  - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 11.1.6 Do not attempt to disassemble the LCD Module.
- 11.1.7 If the logic circuit power is off, do not apply the input signals.
- 11.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - a. Be sure to ground the body when handling the LCD Modules.
  - b. Tools required for assembly, such as soldering irons, must be properly ground.
  - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
  - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

- 11.2 Storage precautions
- 11.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 11.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature:  $0^{\circ}$ C  $\sim 40^{\circ}$ C

Relatively humidity: ≤80%

- 11.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 11.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

Annex A

Inspection items and criteria for appearance defects

Items	Contents		С	ritera			
Protective Glue		No clear defects					
Cover Tape		Covering all of the chip and no clear crimple					
Leakage		Not permitted					
Rainbow	Accoding to the	ne	limit specimen				
	Wrong polarizer attachment	Not permitted					
Polarizer	Bubble between	not counted		Max. 3 defect allowed			
  -	polarizer and glass	ø<0.3mm		0.3mm	m		
	Scratches of polarizer	Accoding to the	he	limit specimen			
		not counted	Max	. 3 spots allowed			
Black spot (in viewing		X<0.20mm	0.20	)mm	Max. 3		
area)	a	X = (a+b)/2	spots				
Black line	4 _	not counted	Max	. 3 lines allowed	(lines) allowed		
(in viewing area)	l b	a<0.02mm	0.02mm≼a≼0.05mm b≼2.0mm				
Progressive cracks		Not permitted					

Annex A

Inspection items and criteria for appearance defects (continued)

Items	Contents	Critera				
Glass Cracks	cracks on pads	а	b	С	Max. 2 cracks allowed	
	b	<3mm	≼W/5	5   ≼T/2		
		<3mm	<w 5<="" td=""><td>5 &gt;T/2</td></w>	5 >T/2		
	cracks on contact side	a b				
		≼ 3m	m	≼T/2		Max. 5
		≤2m	m	T/2 <b<t< td=""><td></td><td>cracks allowed</td></b<t<>		cracks allowed
		c shall be not reach the seal area			Max. 2	allowed
	cracks on non-contact side	а		b	cracks allowed	
		≼ 3m	m	≼T/2		
		≤2m	m	T/2 <b<t< td=""><td colspan="2"></td></b<t<>		
		c <0.5mm				
		d≼sw/3				
	Corner cracks	e<2.0mn f<2.0mm			Max. 3 cracks allowed	

Annex B

Inspection items and criteria for display defects

Items	Contents	Critera			
Open segment or open common		Not permitted			
short		Not permitted			
Wrong viewing angle		Not permitted			
Contrast radio uneven		According to the limit specimen			
Crosstalk		According to the limit specimen			
Pin holes and cracks in segment (DOT)		Not counted	Max. 3 dots allowed		
		X<0.1mm	0.1mm≼X≼0.2mm		
		X=(a+b)/2	Max. 3		
	T D	Not counted	Max. 2 dots allowed	allowed	
		A<0.1mm	0.1mm≼A≼0.2mm D<0.25mm		
Black spot (in viewing area)	Q Q	Not counted	Max. 3 spots allowed		
		X<0.1mm	0.1mm≼X≼0.2mm		
		X=(a+b)/2	Max. 3 spots		
Black line (in viewing area)	1 b	Not counted	Max. 3 lines allowed	(lines) allowed	
		a<0.02mm	0.02mm≼a≼0.05mm b≼0.5mm		

Annex B

Inspection items and criteria for display defects (continued)

Items	Contents	Critera			
Transfor— mation of segment		Not counted	Max. 2 defects allowed		
		X<0.1mm	0.1mm≼X≼0.20mm		
		X=(a+b)/2			
	_	Not counted	Max. 1 defects allowed	Max. 3 defects allowed	
		a<0.1mm	0.1mm≼a≼0.20mm D>0		
		Max. 2 defects allowed 0.8W≤a≤1.2W			
		a=measured value of width W=nominal value of width			